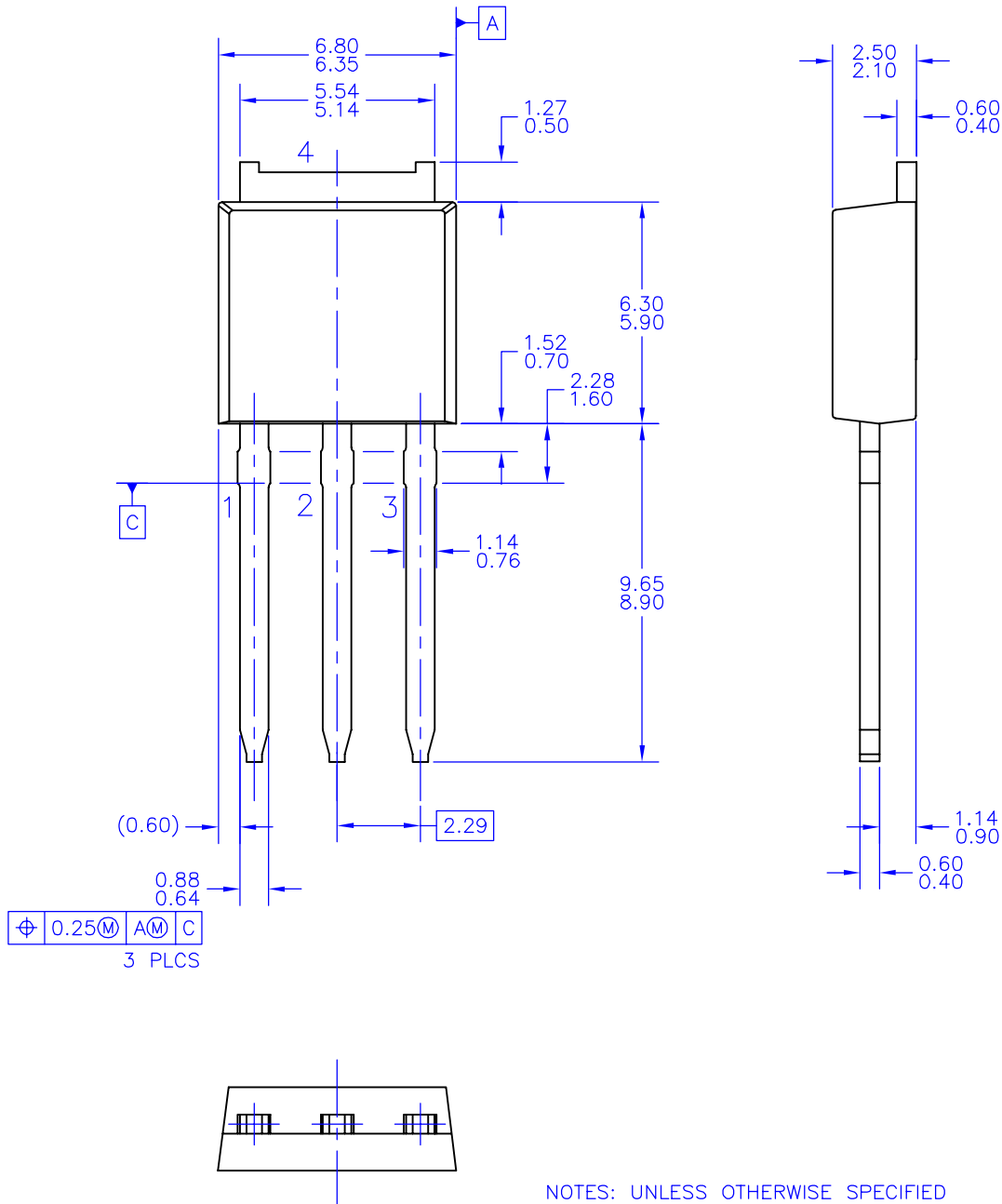


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REVISIONS

LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	CB/031/01	16MAR2001	RM



NOTES: UNLESS OTHERWISE SPECIFIED

- A) ALL DIMENSIONS ARE IN MILLIMETERS.
- B) THIS PACKAGE CONFORMS TO JEDEC, TO-251, ISSUE C, VARIATION AA, DATED SEP 1988.
- C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

TO251A03REVA

APPROVALS		DATE		FAIRCHILD SEMICONDUCTOR™ CEBU PHILIPPINES	
DRAWN: J. GOMEZ		16MAR2001			
CHECKED: R. MANABIT					
APPROVED: M. GESTOLE					
G.S. BAJE				TO-251 (I-PAK) MOLDED, 3 LEAD, OPTION AA	
PROJECTION  1ST ANGLE		SCALE		SIZE	
		8:1		A3	
		FORMERLY: N/A		DRAWING NUMBER	
				MKT-T0251A03	
				REV	
				A	
				SHEET : 1 OF 1	